

SCAN921821 Dual 18-Bit Serializer with Pre-emphasis, IEEE 1149.1 (JTAG), and At-Speed BIST **General Description**

The SCAN921821 is a dual channel 18-bit serializer featuring signal conditioning, boundary SCAN, and at-speed BIST. Each serializer block transforms an 18-bit parallel LVCMOS/ LVTTL data bus into a single Bus LVDS data stream with embedded clock. This single serial data stream with embedded clock simplifies PCB design and reduces PCB cost by narrowing data paths that in turn reduce PCB size and layers. The single serial data stream also reduces cable size, the number of connectors, and eliminates clock-to-data and data-to-data skew.

Each channel also has an 8-level selectable pre-emphasis feature that significantly extends performance over lossy interconnect. Each channel also has its own powerdown pin that saves power by reducing supply current when the channel is not being used.

The SCAN921821 also incorporates advanced testability features including IEEE 1149.1 and at-speed BIST PRBS pattern generation to facilitate verification of board and link integrity

Features

- 15-66 MHz Dual 18:1 Serializer with 2.376 Gbps total throughput
- 8-level selectable pre-emphasis on each channel drives lossy cables and backplanes
- >15kV HBM ESD protection on Bus LVDS I/O pins
- Robust BLVDS serial data transmission with embedded clock for exceptional noise immunity and low EMI
- Power saving control pin for each channel
- IEEE 1149.1 "JTAG" Compliant
- At-Speed BIST PRBS generation
- No external coding required
- Internal PLL, no external PLL components required
- Single +3.3V power supply
- Low power: 260 mW (typ) per channel at 66 MHz with PRBS-15 pattern
- Single 3.3 V supply
- Fabricated with advanced CMOS process technology
- Industrial –40 to +85°C temperature range
- Compact 100-ball FBGA package

Block Diagram



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{DD})	-0.3V to +4V
Supply Voltage (V _{DD})	
Ramp Rate	< 30 V/ms
LVCMOS/LVTTL Input	
Voltage	–0.3V to (V _{DD} +0.3V)
LVCMOS/LVTTL Output	
Voltage	–0.3V to (V _{DD} +0.3V)
Bus LVDS Driver Output	
Voltage	-0.3V to +3.9V
Bus LVDS Output Short	
Circuit Duration	10ms
Junction Temperature	+150°C
Storage Temperature	–65°C to +150°C
Lead Temperature	
(Soldering, 4 seconds)	+220°C
Maximum Package Power	Dissipation at 25°C
FBGA-100	3.57 W

Derating Above 25°C	28.57 mW/°C
Thermal resistance θ_{JA}	35°C/W
θ _{JC}	11.1°C/W
ESD Rating	
HBM, 1.5 KΩ, 100 pF	
All pins	>8 kV
Bus LVDS pins	>15 kV
MM, 0Ω, 200 pF	>1200 V
CDM	>2 kV

Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage (V _{DD})	3.15	3.3	3.45	V
Operating Free Air Temperature (T _A)	-40	+25	+85	°C
Clock Rate	15		66	MHz
Supply Noise			100	mV p-p

DC Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
LVCMOS/L	VTTL Input DC Speci	fications				
V _{IH}	High Level Input Voltage		2.0		V _{DD}	V
V _{IL}	Low Level Input Voltage		GND		0.8	V
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA	-1.5	-0.7		V
I _{INH}	High Level Input Current	$V_{IN} = V_{DD} = V_{DDMAX}$	-20	±2	+20	μΑ
I _{INL}	Low Level Output Current	$V_{IN} = V_{SS}, V_{DD} = V_{DDMAX}$	-10	±2	+10	μΑ
1149.1 (JT	AG) DC Specifications	S				
V _{IH}	High Level Input Voltage		2.0		V _{DD}	V
V _{IL}	Low Level Input Voltage		GND		0.8	V
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA	-1.5	-0.7		V
I _{INH}	High Level Input Current	$V_{IN} = V_{DD} = V_{DDMAX}$	-20		+20	μΑ
I _{INL}	Low Level Output Current	$V_{IN} = V_{SS}, V_{DD} = V_{DDMAX}$	-200		+200	μΑ
V _{OH}	High Level Output Voltage	I _{OH} = -9 mA	2.3		V_{DD}	mV
V _{OL}	Low Level Output Voltage	I _{OL} = 9 mA	GND		0.5	mV
I _{os}	Output Short Circuit Current	V _{OUT} = 0 V	-100	-80	-50	mA
	Output Tri-state	$\overline{\text{PWDN}}$ or EN = 0.8V, V _{OUT} = 0 V	-10		+10	μA
loz	Current	$\overline{\text{PWDN}}$ or EN = 0.8V, V _{OUT} = VDD	-30		+30	μΑ

Symbol	Parameter	Co	Min	Тур	Max	Units	
us LVDS	Output DC Specificatio	ons					
V _{OD}	Output Differential Voltage (DO+) - (DO-)	Figure 10, $R_L = 100\Omega$		450	500	550	mV
ΔV_{OD}	Output Differential Voltage Unbalance				2	15	mV
Vos	Offset Voltage			1.05	1.2	1.25	V
ΔV_{OS}	Offset Voltage Unbalance				2.7	15	mV
		Pre-Empl	nasis Level = 1	1.10	1.24	1.35	
		Pre-Empl	nasis Level = 2	1.35	1.47	1.55	
	Pre-Emphasis Output	Pre-Emphasis Level = 3		1.55	1.70	1.80	
Q _{POV}	Voltage Ratio	Pre-Emphasis Level = 4		1.80	1.91	1.95	
	V _{ODPRE} / V _{OD}	Pre-Emphasis Level = 5		1.95	2.08	2.20	
		Pre-Empl	2.10	2.21	2.35		
		Pre-Empl	nasis Level = 7	2.15	2.30	2.50	
I _{os}	Output Short Circuit Current	DO = 0V, Din = H,	-10	-25	-75	mA	
i	TRI-STATE Output	\overline{PWDN} or $EN = 0$	-10	± 1	+10	μA	
loz	Current	$\overline{\text{PWDN}}$ or $\text{EN} = 0.8$	-55	± 6	+55	μA	
ower Su	pply Current (DVDD, PV	DD and AVDD Pins)					
	Total Supply Current		f = 66 MHz, PRBS-15 Pattern		160	225	mA
Total Supply Current I _{DD} (includes load current)	I _{DD}	$C_L = 15 pF,$ $R_L = 100 \Omega$	f = 66 MHz, Worst Case Pattern (Checker-Board Pattern)		180		mA
	Total Supply Current		f = 66 MHz, PRBS-15 Pattern		240		mA
I _{DDP} with Pre-Emphasis (includes load current)	$C_L = 15pF,$ $R_L = 100 \Omega$ (Checker-Board) Pattern)			280	325	mA	
I _{DDX}	Supply Current Powerdown	PWDN = 0		1.0	3.0	mA	

Over recommended operating supply and temperature ranges unless otherwise specified.

	Parameter	Conditions	Min	Тур	Max	Units
+	Transmit Clock		15.0	т	66.7	
^I TCP	Period		15.2		00.7	115
+	Transmit Clock High		0 4T	0.5T	0 GT	
LTCIH	Time		0.41	0.51	0.01	115
+	Transmit Clock Low		0 4T	0.5T	0 GT	
LTCIL	Time		0.41	0.51	0.01	115
+	TCLK Input			0	6	
^I CLKT	Transition Time			3	0	ns
t _{JIT}	TCLK Input Jitter	(Note 5)			80	ps (RMS)

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AC Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Τνρ	Max	Units
Serializer	AC Specifications			71	-	
	Bus LVDS					
t	Low-to-High			0.3	04	ns
'LLH I	Transition Time	Figure 2, (Note 5)		0.0	0.4	110
	Bus LVDS	R _L = 100Ω,				
t	High-to-Low	C _L =10pF to GND		0.3	04	ns
"LHLI	Transition Time			0.0	0.4	110
	DIN (0-17) Setup to					
t _{DIS}		Figure 4, (Note 5)	1.9			ns
	DIN (0-17) Hold from	$R_{L} = 100\Omega,$				
t _{DIH}		C _L =10pF to GND	0.6			ns
t _{HZD}				3.9	10	ns
		-				
t _{LZD}		Figure 5		3.5	10	ns
		$R_{L} = 100\Omega,$				
t _{zhD}		C _L =10pF to GND		3.2	10	ns
		-				
t _{zLD}				2.4	10	ns
		Figure 7				
t _{SPW}	SYNC Pulse Width	Figure 7, $P = 1000$	$5^{*}t_{TCP}$		6*t _{TCP}	ns
	Sorializar PLL Look	Figure 6				
t _{PLD}	Timo	Figure 0, $R = 1000$	$510*t_{TCP}$		1024*t _{TCP}	ns
+	Serializer Delay	Figure 8 R = 1000	t ⊥25	t ⊥15	t ⊥65	ne
'SD	Channel to Channel	1 igure 0 ; it[= 100s2	TCP + 2.5	TCP + 4.5	TCP + 0.0	115
t _{skcc}	Skow			70		ps
	OKCW	Boom Temperature V - 3 3V				ne
t _{RJIT}	Random Jitter	66 MHz		6.1		(BMS)
	Dotorministic littor	15 MHz	-300		320	(TIMO)
t _{DJIT}	Figure 9 (Note 5)	66 MHz	-60		30	ps
11/0 1 / IT	AG) AC Specification	00 Wi 12	-00		50	ps
1145.1 (01	Maximum TCK Clock	s 				
f _{MAX}	Froquonov		25			MHz
		-				
t _s			2.4			ns
		$C_{L} = 15 pF,$				
t _H	from TCK H or I		2.8			ns
		$R_{L} = 500 \ \Omega$				
t _{w1}			10			ns
		-	10			
۲W2		4	IU			115
t _{REC}			2			ns
-	INSI to ICK					

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 2: Typical values are given for V_{CC} = 3.3V and T_A = +25 $^\circ\text{C}.$

Note 3: Current into device pins is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to ground except VOD, \triangle VOD, VTH and VTL which are differential voltages.

Note 4: I_{OZ} is measured at each pin. The DOUT pin not under test is floated to isolate the TRI-STATE current flow.

Note 5: Guaranteed by Design (GBD) using statistical analysis.

AC Timing Diagrams and Test Circuits



FIGURE 1. "Worst Case" Serializer IDD Test Pattern



FIGURE 2. Serializer Bus LVDS Distributed Output Load and Transition Times







FIGURE 4. Serializer Setup/Hold Times





AC Timing Diagrams and Test Circuits (Continued)







 $\mathsf{V}_{\mathsf{OD}} = (\mathsf{DO}^+) {-} (\mathsf{DO}^-).$

Differential output signal is shown as (DO+)-(DO-), device in Data Transfer mode.

FIGURE 10. V_{OD} Diagram

Pre-emphasis Truth Table

PEM LEVEL	PEM2	PEM1	PEM0
0	L	L	L
1	L	L	Н
2	L	Н	L
3	L	Н	Н
4	Н	L	L
5	Н	L	Н
6	Н	Н	L
7	Н	Н	Н

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Pin Diagram									
				SCAN92 Top	1821TVV View				
A1	A2	A3	A4	A5	A6	A7		(A9)	A10
BISTB	PV _{SS}	DOUTBN	AV _{DD}	ENB	AV _{DD}	DOUTAN		AV _{DD}	ENA
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10
DINB16	SYNCB	AV _{DD}	DOUTBP	AV _{DD}	PEMB1	AV _{SS}	PEMB0	PEMA1	BISTA
C1	C2	C3	C4	C5	C6	C7	C8	C9	C10
DINB14	DV _{DD}	DV _{SS}	AV _{SS}	AV _{SS}	AV _{SS}	AV _{DD}	PEMA2	SYNCA	DINA16
D1 DINB13	D2 DINB12	D3 DINB17	D4 DV _{DD}	$ODS PV_{DD}$	D6 PEMA0	D7 AV _{SS}	D8 DINA17	D9 DINA15	DINA13
E1	E2	E3	E4	E5	E6	E7	E8	E9	E10
DINB11	DINB9	DINB15	DV _{SS}	DINB8	PEMB2	DV _{SS}	DINA14	DINA12	DINA9
F1	F2	F3	F4	F5	F6	F7	F8	F9	F10
DINB10	DINB7	DINB5	DV _{SS}	PV _{DD}	DINA11	DV _{SS}	DINA4	DINA10	DINA8
G1	G2	G3	G4	G5	G6	G7	G8	G9	G10
DINB6	DINB4	DINB2	DV _{SS}	DV _{DD}	DV _{DD}	DINA1	DINA2	DINA7	DINA6
H1	H2	H3	H4	H5	H6	H7	H8	H9	H10
DINB3	DINB1	TxCLK	DV _{SS}	TCK	PV _{DD}	PV _{SS}	DV _{SS}	DINA0	DINA5
J1	J2	J3	J4	J5	J6	J7	J8	J9	J10
DINB0	PWDNA	DV _{DD}	TRST	PV _{DD}	PV _{SS}	PV _{DD}	NC	DV _{DD}	DINA3
K1	K2	K3	K4	K5	K6	K7	K8	K9	
DV _{SS}	TDI	TMS	DV _{SS}	TDO	DV _{DD}	PV _{SS}	PV _{SS}	PWDNB	
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Pin Descriptions							
Pin Name	Pin Count	I/O, Type	Description				
DATA PINS							
DINA0-17	18		Transmitter inputs. There is a pull-down circuitry on each of these pins which are				
DINB0-17	18		active if respective PWDNA or PWDNB pin is pulled high.				
DOUTAP	1						
DOUTAN	1		Investing and pap investing differential transmitter outputs				
DOUTBP	1	U,BLVDS					
DOUTAN	1						
TIMING AND C	CONTROL PINS						
TxCLK	1	I, LVCMOS	Transmitter reference clock. Used to strobe data at the inputs and to drive the transmitter PLL. There is a pull-up circuitry on this pin which is always active.				
ENA	1		Transmitter outputs enable pins. There is a pull-down circuitry on each of these pins that are active if corresponding PWDNA or PWDNB pin is pulled high.				
ENB	1		When these pins are set to LOW, the transmitter outputs will be disabled. The PLL will remain locked.				
PWDNA	1		Stand-by mode pins. There is a pull-down circuitry on each of these pins that are				
PWDNB	1		power mode and the PLL will lose lock.				
SYNCA	1		Transmitter synchronization pins. There is a pull-down circuitry on each of these pins that are active if corresponding PWDNA or PWDNB pin is pulled high.				
SYNCB	1		When these pins are set to HIGH, the transmitter will ignore incoming data a send SYNC patterns to provide a locking reference to receiver(s).				
PRE-EMPHAS	IS PINS	•					
PEMA0-2	3		8-level pre-emphasis selection pins. There is a pull-down circuitry on each of				
PEMB0-2	3	I, LVCMOS	these pins which are active it corresponding PWDNA or PWDNB pin is pulled high.				
JTAG PINS							
TDI	1	I, LVCMOS	Test Data Input to support IEEE 1149.1. There is a pull-up circuitry on this pin which is always active.				
TDO	1	O, LVCMOS	Test Data Output to support IEEE 1149.1.				
TMS	1	I, LVCMOS	Test Mode Select Input to support IEEE 1149.1. There is a pull-up circuitry on this pin which is always active.				
ТСК	1	I, LVCMOS	Test Clock Input to support IEEE 1149.1. There is no failsafe circuitry on this pin.				
TRST	1	I, LVCMOS	Test Reset Input to support IEEE 1149.1. There is a pull-up circuitry on this pin which is always active.				
BIST PINS							
BISTA	1	I, LVCMOS	BIST selection pins. These pins select which transmitter will generate a PRBS				
BISTB	1		like data. There is a pull-down circuitry on these pins which are active if corresponding PWDNA or PWDNB pin is pulled high.				
POWER PINS							
AVDD	6	I, POWER	Power Supply for the LVDS circuitry.				
DVDD	8	I, POWER	Power Supply for the digital circuitry.				
PVDD	5	I, POWER	Power Supply for the PLL and BG circuitry.				
AVSS	5	I, POWER	Ground reference for the LVDS circuitry.				
DVSS	10	I, POWER	Ground reference for the digital circuitry.				
PVSS	5	I, POWER	Ground reference for the PLL and BG circuitry.				
OTHER PINS							
NC	1	N/A	Not connected.				

